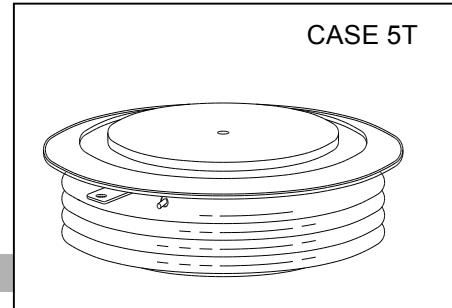


KP1300A/6500V

HIGH POWER THYRISTOR FOR PHASE CONTROL APPLICATIONS

Features:

- . All Diffused Structure
- . Spoke Amplifying Gate Configuration
- . Blocking capability up to 6500volts
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

Device Type	V _{RRM} (1)	V _{DRM} (1)	V _{RSM} (1)
KP1000	5800	5800	6000
KP1000	6200	6200	6400
KP1000	6500	6500	6700

V_{RRM} = Repetitive peak reverse voltage

V_{DRM} = Repetitive peak off state voltage

V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage and off state leakage	I _{RRM} / I _{DRM}	20 mA 400mA (3)
Critical rate of voltage rise	dV/dt (4)	2000V/ μ sec

Notes:

All ratings are specified for T_j=25 °C unless otherwise stated.

(1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to +125 °C.

(2) 10 msec. max. pulse width

(3) Maximum value for T_j = 125 °C.

(4) Minimum value for linear and exponential waveshape to 70% rated V_{DRM}. Gate open. T_j = 125 °C.

(5) Non-repetitive value.

(6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μ F capacitor and 20 ohms resistance in parallel with the thristor under test.

Conducting - on state

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	I _{T(AV)}		1300		A	Sinewave, 180° conduction, T _c =85°C
RMS value of on-state current	I _{TRMS}		2000		A	Nominal value
Peak one cycle surge (non repetitive) current	I _{TSM}		22000		A	10.0 msec (50Hz), sinusoidal wave- shape, 180° conduction, T _j = 125 °C
I square t	I ² t		2.4		KA ² s	10.0 msec
Latching current	I _L		150		A	V _D = 24 V; R _L = 12 ohms
Holding current	I _H		80		mA	V _D = 24 V; I = 2.5 A
Peak on-state voltage	V _{TM}		3.00		V	I _{TM} = 3000 A; Duty cycle ≤ 0.01%
Critical rate of rise of on-state current (5, 6)	di/dt		200		A/ μ s	Switching from V _{DRM} ≤ 3000 V, non-repetitive
Critical rate of rise of on-state current (6)	di/dt		100		A/ μ s	Switching from V _{DRM} ≤ 3000 V

Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	P _{GM}		200		W	t _p = 40 us
Average gate power dissipation	P _{G(AV)}		5		W	
Peak gate current	I _{GM}		20		A	
Gate current required to trigger all units	I _{GT}		300		mA	V _D = 6 V; R _L = 3 ohms; T _j = +25 °C
Gate voltage required to trigger all units	V _{GT}		3		V	V _D = 6 V; R _L = 3 ohms; T _j = 25°C
Peak negative voltage	V _{GRM}		20		V	

Dynamic

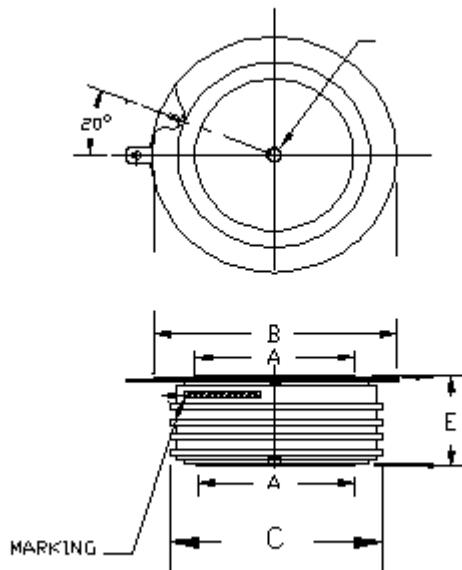
Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	t _d		3.0		μs	I _{TM} = 50 A; V _D = 2000 V Gate pulse: V _G = 20 V; R _G = 20 ohms; t _r = 0.1 μs; t _p = 20 μs
Turn-off time (with V _R = -50 V)	t _q		700	250	μs	I _{TM} > 2000 A; di/dt = 10 A/μs; V _R ≥ -50 V; Re-applied dV/dt = 500 V/μs linear to 2000 V; V _G = 0; T _j = 125 °C; Duty cycle ≥ 0.01%
Reverse recovery current	I _{rr}				A	I _{TM} > 2000 A; di/dt = 10 A/μs; V _R ≥ -50 V

THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T _j	-40	+125		°C	
Storage temperature	T _{stg}	-40	+150		°C	
Thermal resistance - junction to case	R _{θ(j-c)}		0.006		°C/W	Double sided cooled
Thermal resistamce - case to sink	R _{θ(c-s)}		0.002		°C/W	Double sided cooled * *
Mounting force	F		60		kN	

* Mounting surfaces smooth, flat and greased

Note : for case outline and dimensions, see case outline drawing in page 3 of this Technical Data



A: 73 mm

B: 110 mm

C: 98 mm

E: 36 mm